

# SMAG Plastic-Encapsulate Diodes

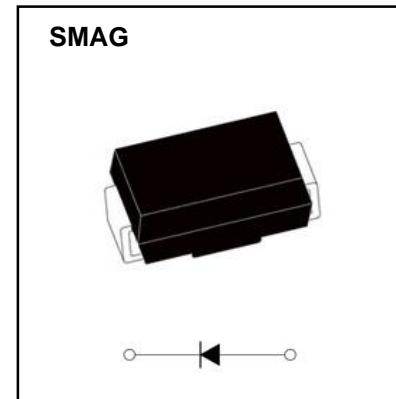
## Schottky Rectifier

### Features

- $I_o$  3A
- VRMM 20V-200V
- Low forward voltage drop
- High surge current capability
- Metal silicon junction, majority carrier conduction

### Mechical Data

- Case: JEDEC DO-214AC molded plastic
- Molding compound: UL flammability classification rating 94V-0
- Terminals: Solder plated, solderable per MIL-STD-202, Method 208
- Polarity: Color band denotes cathode end



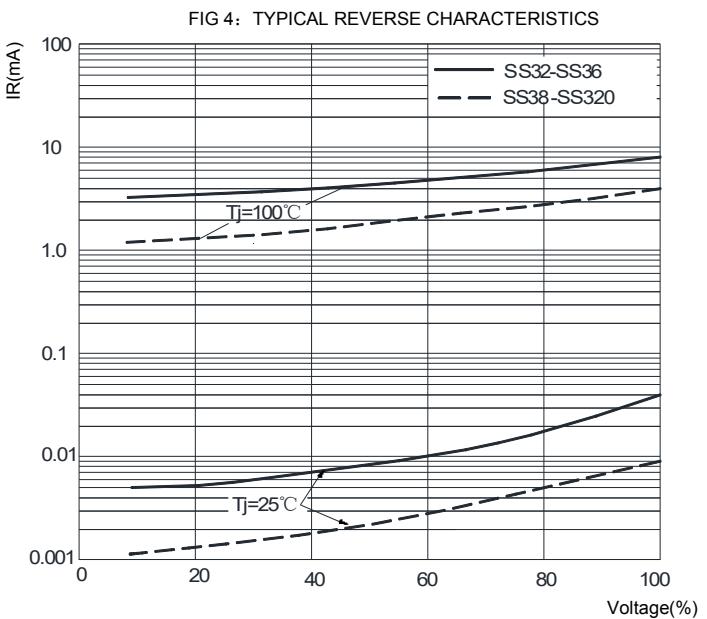
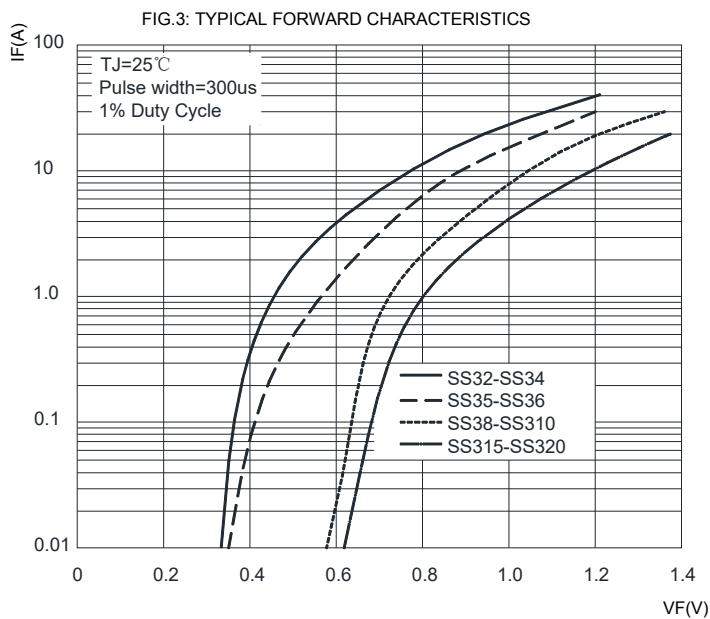
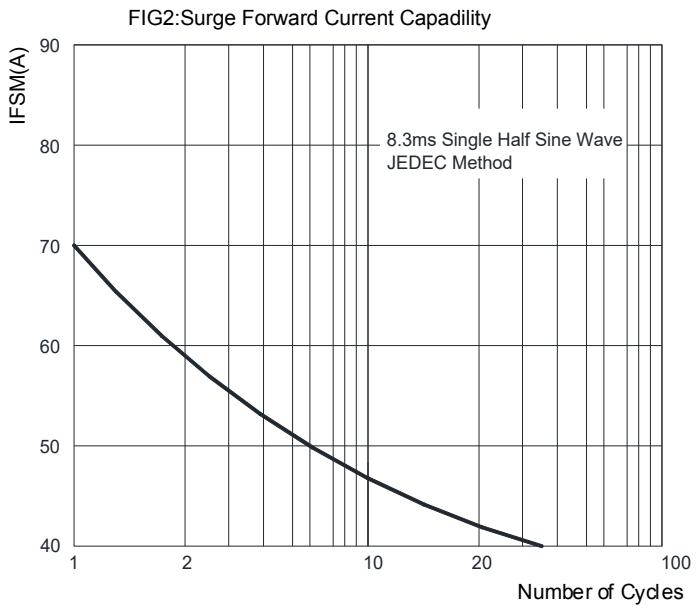
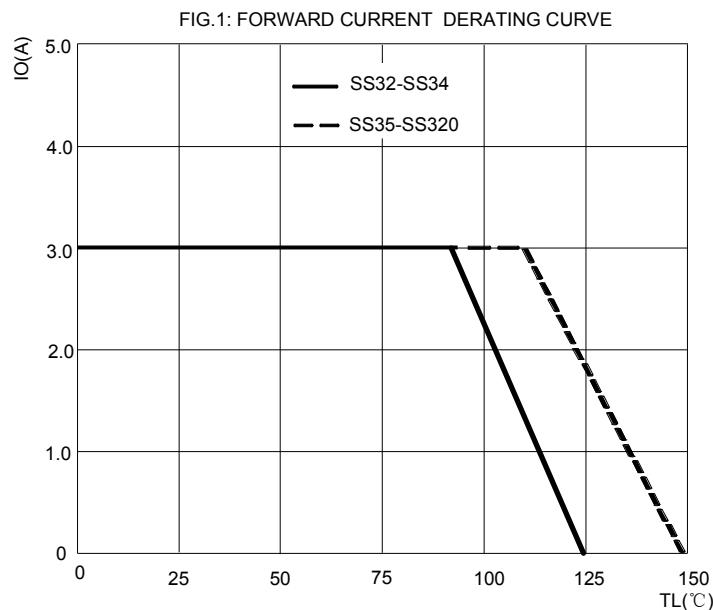
### Limiting Values (Absolute Maximum Rating)

Item	Symbol	Unit	Test Conditions	SS 32	SS 33	SS 34	SS 35	SS 36	SS 38	SS 310	SS 315	SS 320
Repetitive Peak Reverse Voltage	$V_{RRM}$	V		20	30	40	50	60	80	100	150	200
Maximum RMS Voltage	$V_{RMS}$	V		14	21	28	35	42	56	70	105	140
Maximum DC Blocking Voltage	$V_{DC}$	V		20	30	40	50	60	80	100	150	200
Average Forward Current	$I_{F(AV)}$	A	60Hz Half-sine wave, Resistance load, TL(Fig.1)							3.0		
Surge(Non-repetitive)Forward Current	$I_{FSM}$	A	60Hz Half-sine wave ,1 cycle , $T_a = 25^\circ C$							70		
Junction Temperature	$T_J$	°C				-55~+125				-55~+150		
Storage Temperature	$T_{STG}$	°C								-55 ~ +150		

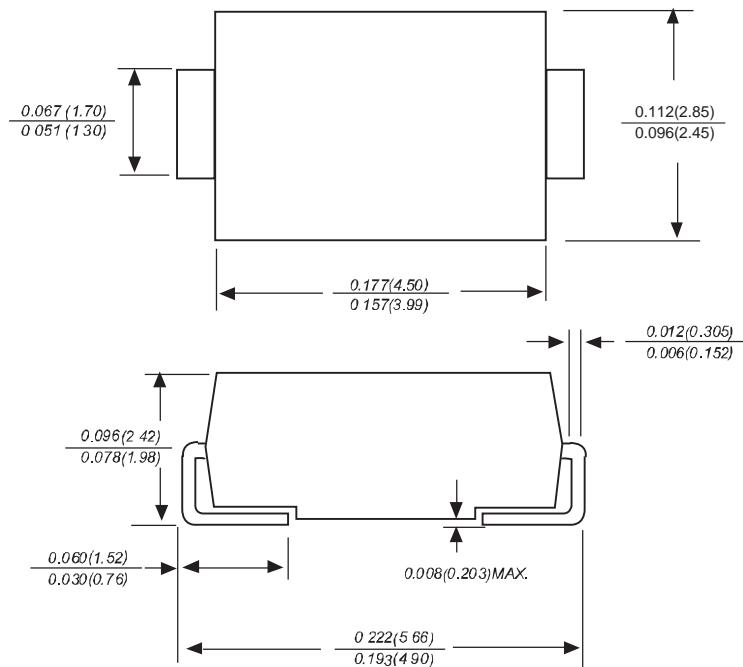
### Electrical Characteristics ( $T_a=25^\circ C$ Unless otherwise specified)

Item	Symbol	Unit	Test Condition	SS 32	SS 33	SS 34	SS 35	SS 36	SS 38	SS 310	SS 315	SS 320
Peak Forward Voltage	$V_F$	V	$I_F = 3.0A$		0.55		0.70		0.85		0.95	
Peak Reverse Current	$I_{RRM1}$	mA	$V_{RM} = V_{RRM}$	$T_a = 25^\circ C$		0.5					0.1	
	$I_{RRM2}$					10					5.0	
Thermal Resistance(Typical)	$R_{\theta J-A}$	°C/W	Between junction and ambient							70		
	$R_{\theta J-L}$		Between junction and terminal							30		
	$R_{\theta J-C}$		Between junction and case							25		
Junction Capacitance (Typical)	$C_J$	pF	Measured at 1.0MHz and applied reverse voltage of 4.0 volts.		140		120		100		50	

## Typical Characteristics

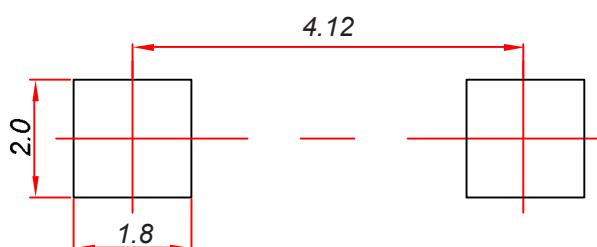


## SMAG Package Outline Dimensions



Dimensions in inches and (millimeters)

## SMAG Suggested Pad Layout



### Note:

1. Controlling dimension: in millimeters.
2. General tolerance:  $\pm 0.05$  mm.
3. The pad layout is for reference purposes only.

## Ordering Information

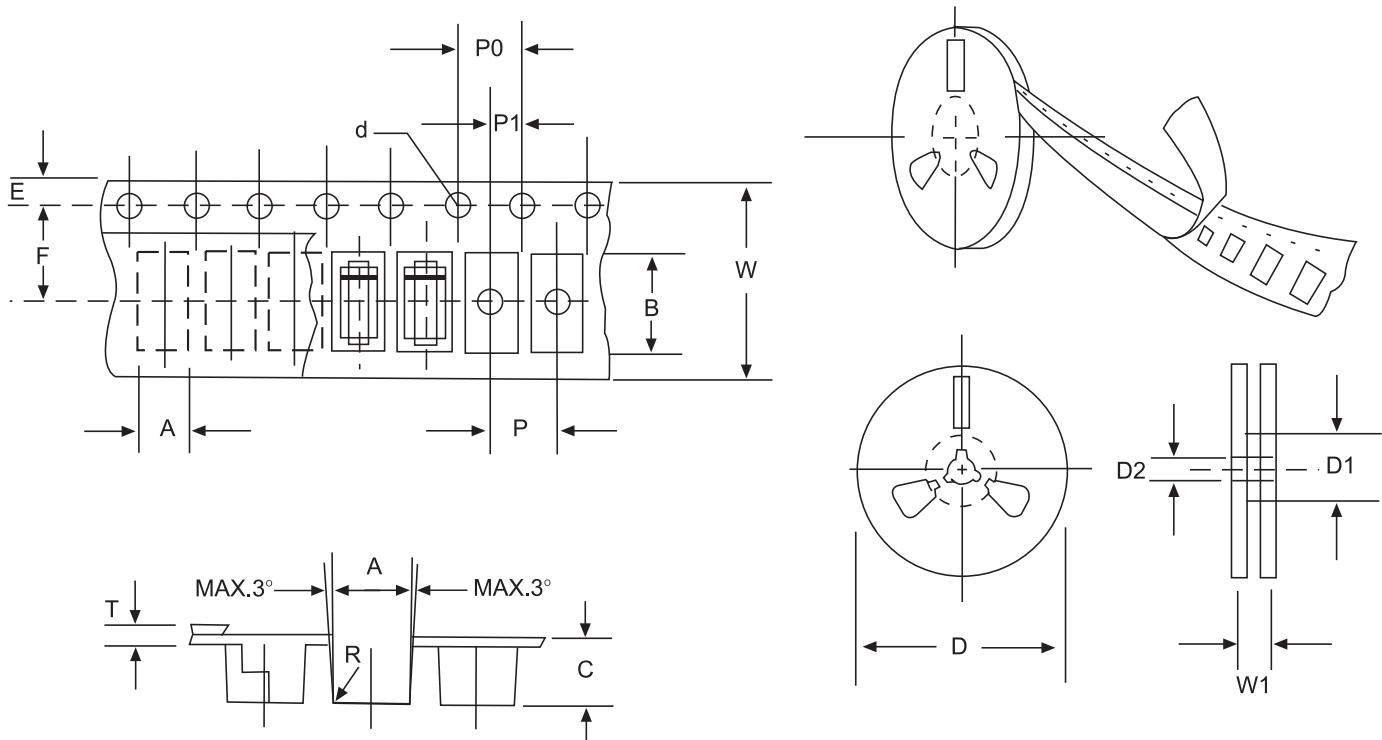
Part Number	Package	Shipping Quantity
SS32-SS320	SMAG	5000/tape&Reel

## Marking Diagram



X: From 2 To 20

## Reel Taping Specifications For Surface Mount Devices- SMAG



**Fig:CONFIGURATION OF FLAT MELF TAPING**

ITEM	SYMBOL	SMAG mm(inch)
Carrier width	A	$2.79 \pm 0.1$ ( $0.110 \pm 0.004$ )
Carrier length	B	$5.33 \pm 0.1$ ( $0.210 \pm 0.004$ )
Carrier depth	C	$2.36 \pm 0.1$ ( $0.093 \pm 0.004$ )
Sprocket hole	d	$1.55 \pm 0.05$ ( $0.061 \pm 0.002$ )
Reel outside diameter	D	$279 \pm 2.0$ ( $11 \pm 0.079$ )
Reel inner diameter	D1	$75 \pm 1.0$ ( $2.95 \pm 0.039$ )
Feed hole diameter	D2	$13 \pm 0.5$ ( $0.512 \pm 0.020$ )
Stroket hole position	E	$1.75 \pm 0.1$ ( $0.069 \pm 0.004$ )
Punch hole position	F	$5.5 \pm 0.05$ ( $0.217 \pm 0.002$ )
Punch hole pitch	P	$4.0 \pm 0.1$ ( $0.157 \pm 0.004$ )
Sprocket hole pitch	P0	$4.0 \pm 0.1$ ( $0.157 \pm 0.004$ )
Embossment center	P1	$2.0 \pm 0.1$ ( $0.079 \pm 0.004$ )
Total tape thickness	T	$0.28 \pm 0.02$ ( $0.011 \pm 0.0008$ )
Tape width	W	$12.0 \pm 0.2$ ( $0.472 \pm 0.008$ )
Reel width	W1	$16.8 \pm 2.0$ ( $0.661 \pm 0.079$ )

NOTE:Devices are packde in accordance with EIA standard RS-481-A and specification given above.